



A Product Line of Diodes Incorporated

ZXTN2031F

50V NPN MEDIUM POWER TRANSISTOR IN SOT23

Features

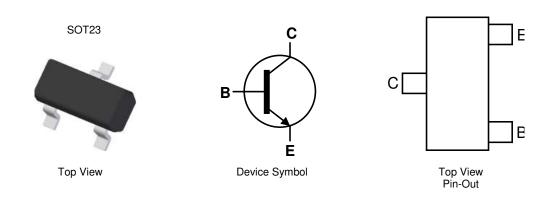
- $BV_{CEO} > 50V$
- BV_{CEV} > 80V Forward Blocking Voltage
- I_C = 5A high Continuous Collector Current
- I_{CM} = 12A Peak Collector Current
- Low Saturation Voltage, V_{CE(SAT)} < 40mV @1A
- $R_{CE(SAT)} = 24m\Omega$ for a Low Equivalent On-Resistance
- Complementary PNP Type: ZXTP2025F
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 03
- Weight 0.008 grams (Approximate)

Applications

- MOSFET and IGBT Gate Driving
- Motor Drive
- Relay Lamp and Solenoid Drive
- **DC-DC Converters**



Ordering Information (Note 4)

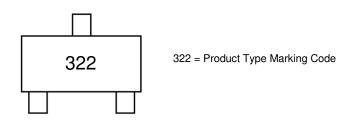
	Product	Compliance	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel	
ZXTN2031FTA		AEC-Q101	322	7	8	3,000	
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.							

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + CI) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http"//www.diodes.com/products/packages.html.

Marking Information





Absolute Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	80	V
Collector-Emitter Voltage	V _{CEV}	80	V
Collector-Emitter Voltage	V _{CEO}	50	V
Emitter-Base Voltage	V _{EBO}	7	V
Continuous Collector Current	Ic	5	A
Peak Pulse Current	Ісм	12	A
Base Current	IB	1.2	A

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
	(Note 5)		1.0 8.0		
Power Dissipation Linear Derating Factor	(Note 6)	P _D	1.2 9.6	W mW/°C	
	(Note 7)		1.56 12.5		
Thermal Resistance, Junction to Ambient	(Note 5) (Note 6)	R _{θJA}	125 104	°C/W	
	(Note 7)		80		
Thermal Resistance, Junction to Lead	(Note 8)	R _{θJL}	57	°C/W	
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C		

ESD Ratings (Note 9)

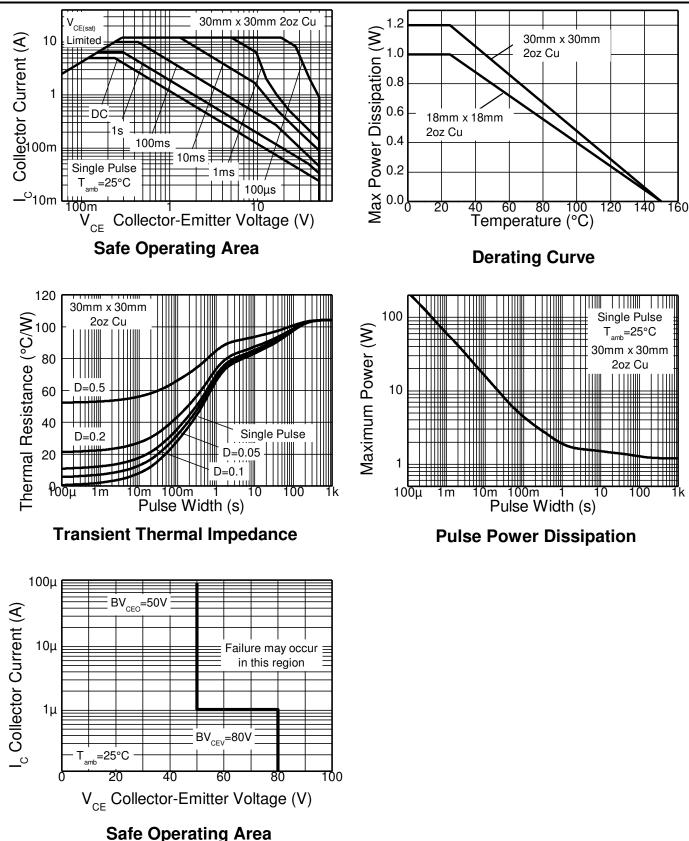
Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	ЗA
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

Notes: 5. For a device mounted with the collector lead on 18mm x 18mm 2oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air For a device mounted with the collector lead on 18mm x 18mm 202 copper that is conditions whilst operating in steady-state.
Same as note (5), except the device is mounted on 30mm x 30mm 202 copper.
Same as note (6), except measured at t < 5 seconds.
Thermal resistance from junction to solder-point (at the end of the collector lead).
Refer to JEDEC specification JESD22-A114 and JESD22-A115.













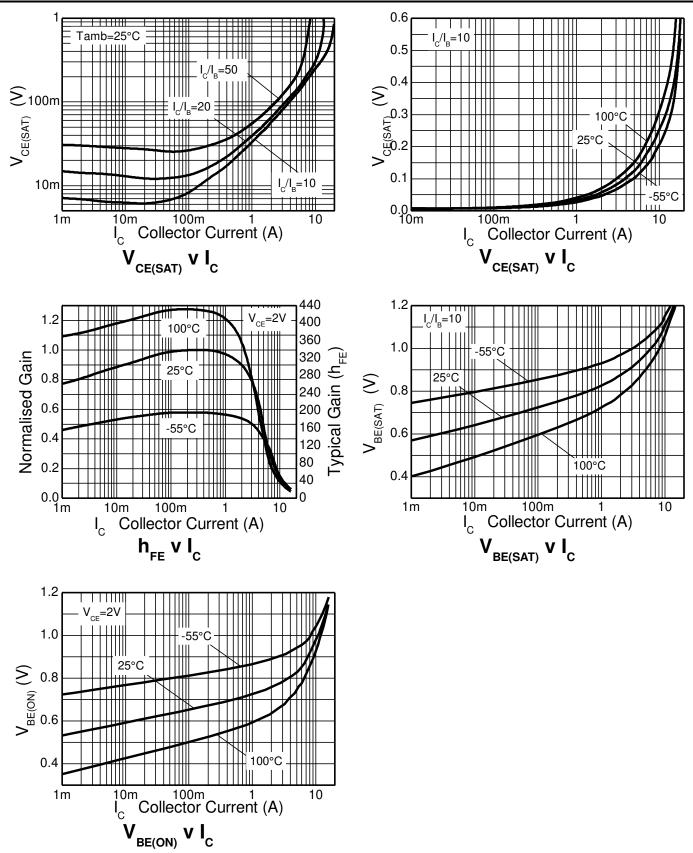
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV _{CBO}	80	175	-	V	I _C = 100μA
Collector-Emitter Breakdown Voltage	BV _{CEV}	80	175	-	V	$I_{C} = 1\mu A$, $-1V < V_{BE} < +0.3V$
Collector-Emitter Breakdown Voltage (Note 10)	BV _{CEO}	50	75	-	V	$I_{\rm C} = 10 {\rm mA}$
Emitter-Base Breakdown Voltage	BV _{EBO}	7	8.3	-	V	I _E = 100μA
Collector – Emitter Cut-Off Current	ICEV	-	<1	20	nA	$V_{CE} = 60V, V_{BE} = -1V$
Collector - Base Cut-Off Current	I _{CBO}	-	<1	20	nA	$V_{CB} = 60V$
Emitter Cut-off Current	I _{EBO}	-	<1	10	nA	V _{EB} = 6V
Static Forward Current Transfer Ratio (Note 10)	hfe	190 200 200 80	300 350 340 125	- 560 - -	-	$ I_{C} = 10mA, V_{CE} = 2V \\ I_{C} = 500mA, V_{CE} = 2V \\ I_{C} = 2A, V_{CE} = 2V \\ I_{C} = 5A, V_{CE} = 2V $
Collector-Emitter Saturation Voltage (Note 10)	V _{CE(sat)}		13 30 80 135	18 40 110 170	mV	$I_{C} = 100 \text{mA}, I_{B} = 5 \text{mA}$ $I_{C} = 1 \text{A}, I_{B} = 100 \text{mA}$ $I_{C} = 2 \text{A}, I_{B} = 40 \text{mA}$ $I_{C} = 5 \text{A}, I_{B} = 250 \text{mA}$
Base-Emitter Saturation Voltage (Note 10)	V _{BE(sat)}	-	800 920	900 1000	mV	$I_{C} = 2A, I_{B} = 40mA$ $I_{C} = 5A, I_{B} = 250mA$
Base-Emitter Turn-On Voltage (Note 10)	V _{BE(on)}	-	830	930	mV	$I_{C} = 5A, V_{CE} = 2V$
Transition Frequency	FT	-	125	-	MHz	$I_{C} = 500 \text{mA}, V_{CE} = 10 \text{V}, f = 50 \text{MHz}$
Output Capacitance	Cobo	-	29	-	pF	V _{CB} = 10V, f=1MHz
Delay Time	t _(d)	-	16	-	ns	
Rise Time	t _(r)	-	27	-	ns	$V_{CC} = 12V, I_C = 2.5A,$
Storage Time	t _(stg)	-	468	-	ns	$I_{B1} = -I_{B1} = 125 \text{mA}$
Fall Time	t _(f)	-	44	-	ns	7

10. Measured under pulsed conditions. Pulse width \leq 300µs. Duty cycle \leq 2% Note:





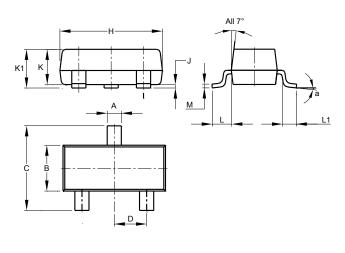




FX

Package Outline Dimensions

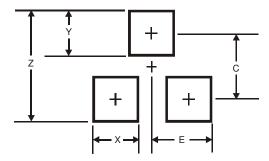
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



	SOT23						
Dim	Min	Max	Тур				
Α	0.37	0.51	0.40				
В	1.20	1.40	1.30				
С	2.30	2.50	2.40				
D	0.89	1.03	0.915				
F	0.45	0.60	0.535				
G	1.78	2.05	1.83				
н	2.80	3.00	2.90				
J	0.013	0.10	0.05				
К	0.890	1.00	0.975				
K1	0.903	1.10	1.025				
L	0.45 0.61 0.5						
L1	0.25	0.55	0.40				
М	0.085	0.150	0.110				
а	a 8°						
All Dimensions in mm							

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Y	0.9
С	2.0
E	1.35



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